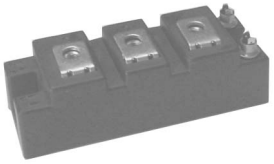
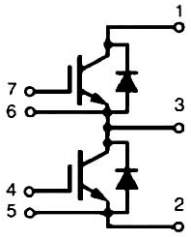
查询"SII75N12"供应商

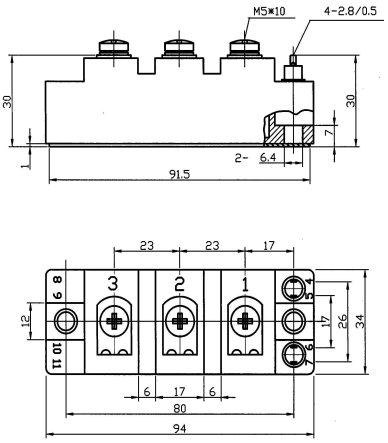
SII75N12

NPT IGBT Modules





Dimensions in mm (1mm = 0.0394")



Absolute Maximum Ratings T_C = 25°C, unless otherwise specified

Symbol	Conditions	Values	Units
V_{CES}		1200	V
I_C	T_C= 25(80)°C	105(75)	A
I_{CRM}	T_C= 25(80)°C, t_P =1ms	210(150)	A
V_{GES}		±20	V
P_{tot}		625	W
T_{Vj},(T_{stg})	$T_{OPERATION} \leq T_{stg}$	−40...+125(150)	°C
V_{isol}	AC, 1min	2500	V
R_{thJC}		≤ 0.2	K/W
R_{thJCD}		≤ 0.5	

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Electeical Characteristics $T_C = 25^oC$, unless otherwise specified

Symbol	Conditions	min.	typ.	max.	Units
Static Characteristics					
$V_{GE(th)}$	$V_{GE} = V_{CE}$, I_C =3mA	4.5	5.5	6.5	V
I_{CES}	V_{GE} = 0; V_{CE} = 1200V; T_j = 25(125)^oC		1(4.5)	1.5	mA
I_{GES}	V_{GE} = 20V, V_{CE} = 0			320	nA
$V_{CE(sat)}$	I_C =75A; V_{GE} = 15V; T_j = 25(125)^oC; chip level		2.5(3.1)	3(3.7)	V
AC Characteristics					
C_{ies}	under following conditions		5.5		nF
C_{oes}	V_{GE} = 0, V_{CE} = 25V, f = 1MHz		0.8		
C_{res}			0.3		
g_{fs}	V_{CE}=20V, I_C=75A	31			S
Switching Characteristics					
$t_{d(on)}$	V_{CC} = 600V, I_C = 75A		30	60	ns
t_r	R_{Gon} = R_{Goff} =15Ω, T_j = 125^oC		70	140	
$t_{d(off)}$	V_{GE} = ± 15V		450	600	
t_f			70	100	
FWD under following conditions:					
V_F	I_F = 75A, V_{GE} = 0V, T_j = 25(125)^oC		2.3(1.8)	2.8	V
t_{rr}	I_F =75A, V_R=–600V, V_{GE}=0V,di/dt=–900A/us, T_j = 125^oC		0.125		us
Q_{rr}	I_F = 75A, V_{GE} = 0V, V_R= –600V di/dt=– 900A/us, T_j = 25(125)^oC		3.2(12)		uC
Mechanical Data					
M_s	to heatsink M6	3		5	Nm
M_t	to terminals M5	2.5		5	Nm
w				160	g

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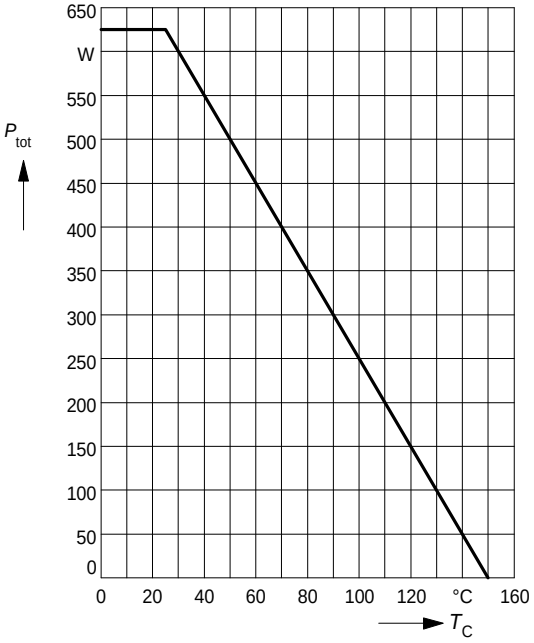
Power dissipation

$P_{tot} = f(T_C)$

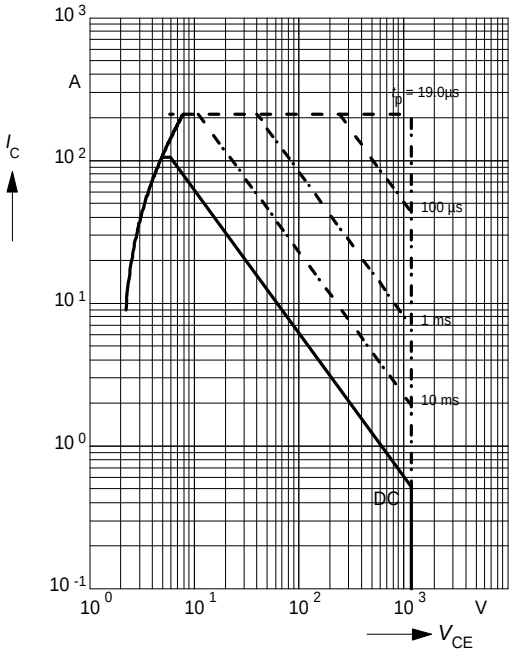
parameter: $T_j \leq 150$ °C



Safe operating area

$I_C = f(V_{CE})$

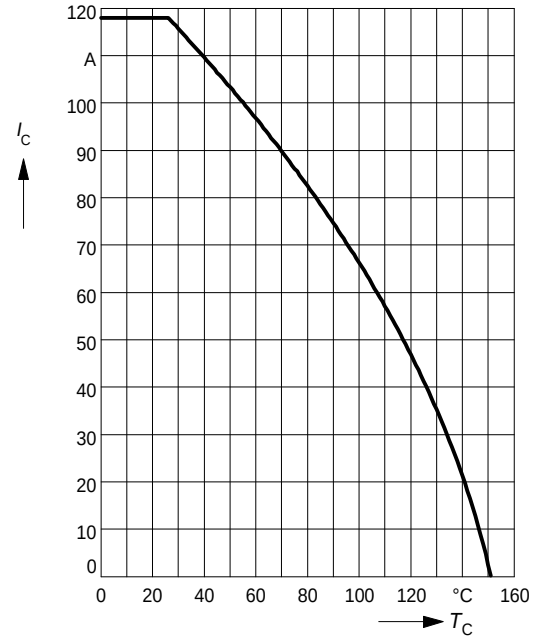
parameter: $D = 0$, $T_C = 25$°C , $T_j \leq 150$ °C



Collector current

$I_C = f(T_C)$

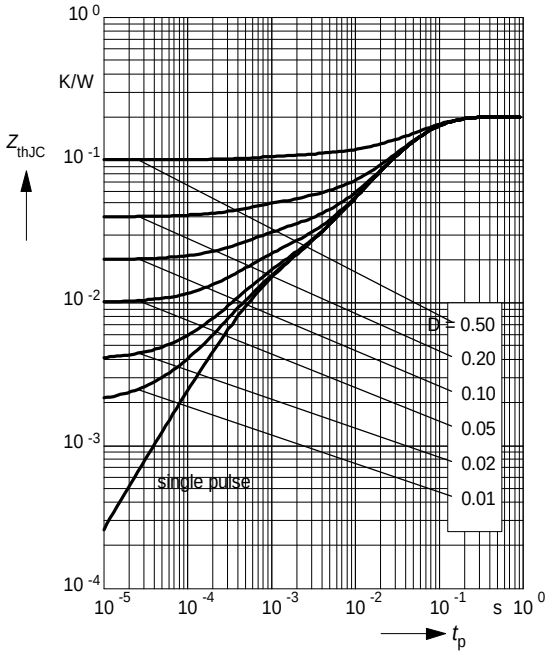
parameter: $V_{GE} \geq 15$ V , $T_j \leq 150$ °C



Transient thermal impedance IGBT

$Z_{th\,JC} = f(t_p)$

parameter: $D = t_p / T$



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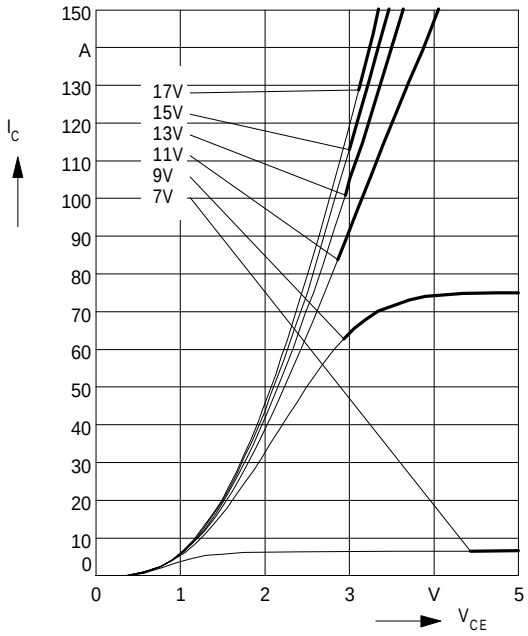
Typ. output characteristics

$I_C = f(V_{CE})$

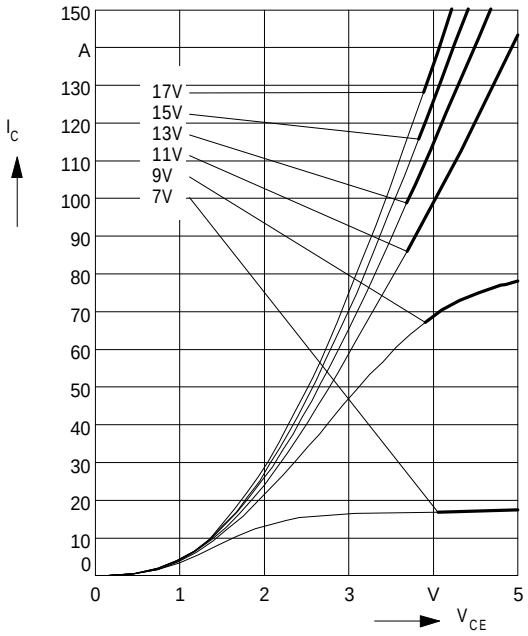
parameter: $t_p = 80\ \mu s$, $T_j = 25\ °C$



Typ. output characteristics

$I_C = f(V_{CE})$

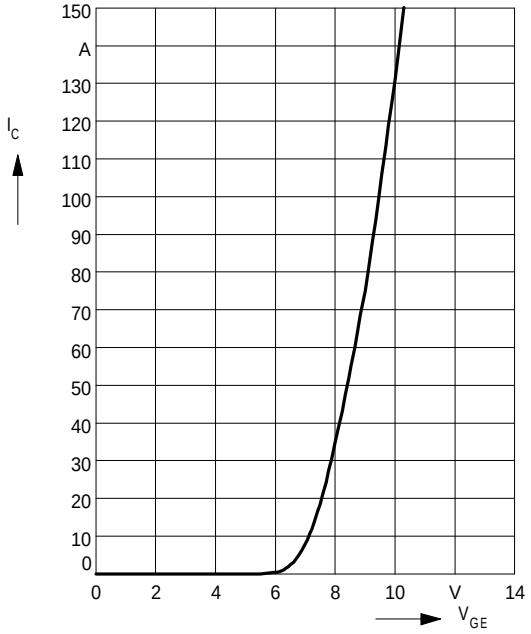
parameter: $t_p = 80\ \mu s$, $T_j = 125\ °C$



Typ. transfer characteristics

$I_C = f(V_{GE})$

parameter: $t_p = 80\ \mu s$, $V_{CE} = 20\ V$



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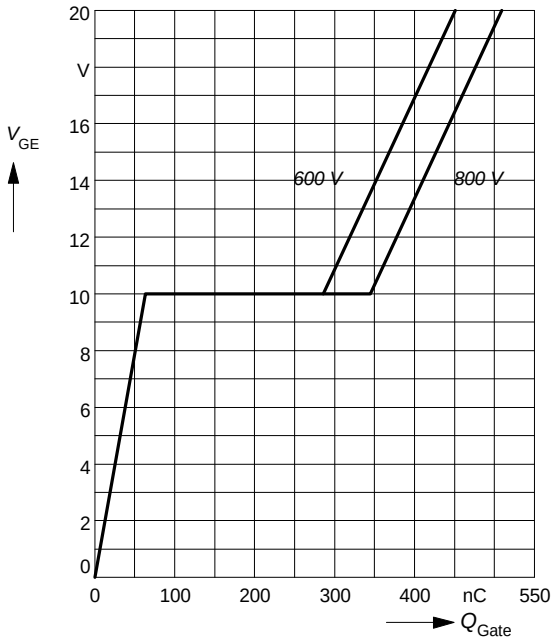
Typ. gate charge

$V_{GE} = f(Q_{Gate})$

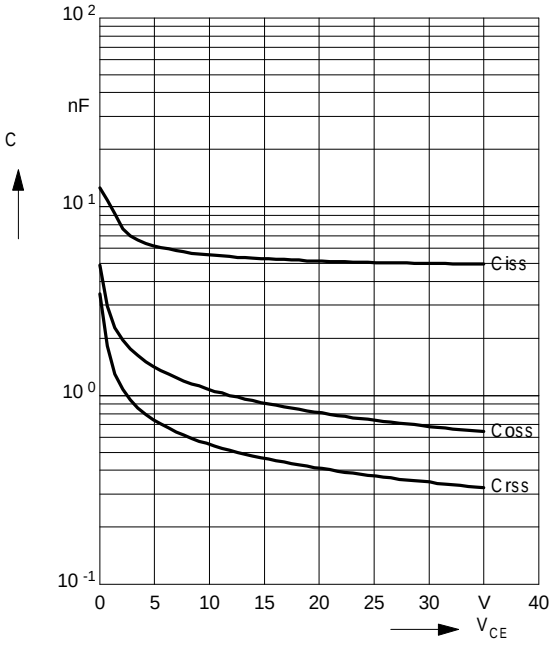
parameter: $I_{C\ puls}$ = 75 A



Typ. capacitances

$C = f(V_{CE})$

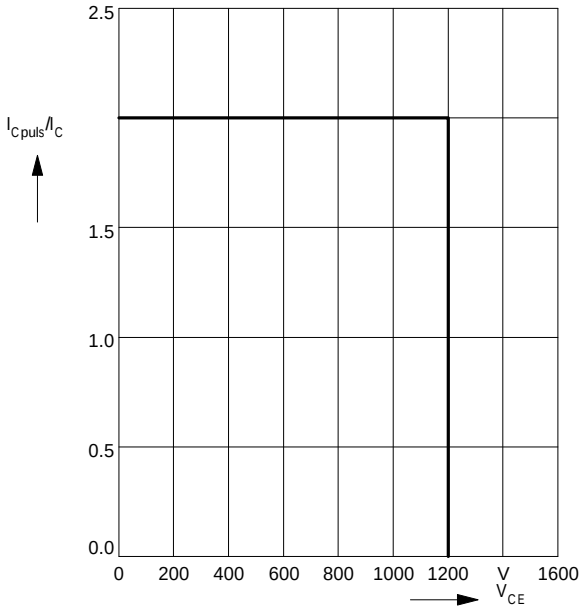
parameter: V_{GE} = 0, f = 1 MHz



Reverse biased safe operating area

$I_{C\ puls} = f(V_{CE})$, T_j = 150°C

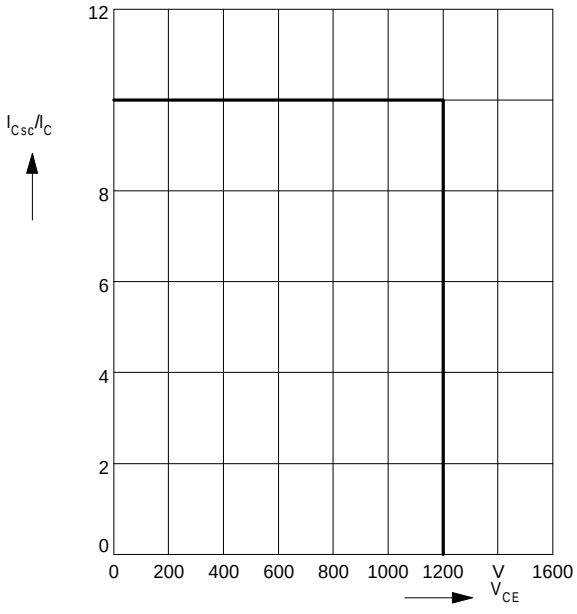
parameter: V_{GE} = 15 V



Short circuit safe operating area

$I_{Csc} = f(V_{CE})$, T_j = 150°C

parameter: V_{GE} = ± 15 V, $t_{SC} \leq$ 10 µs, L < 50 nH



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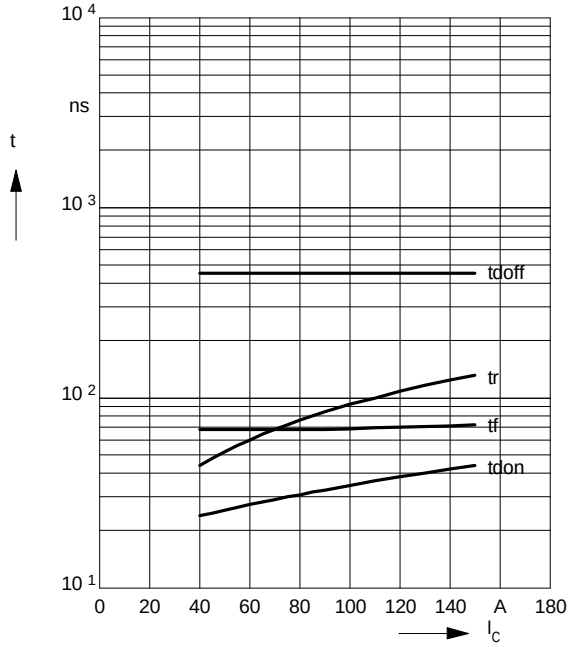
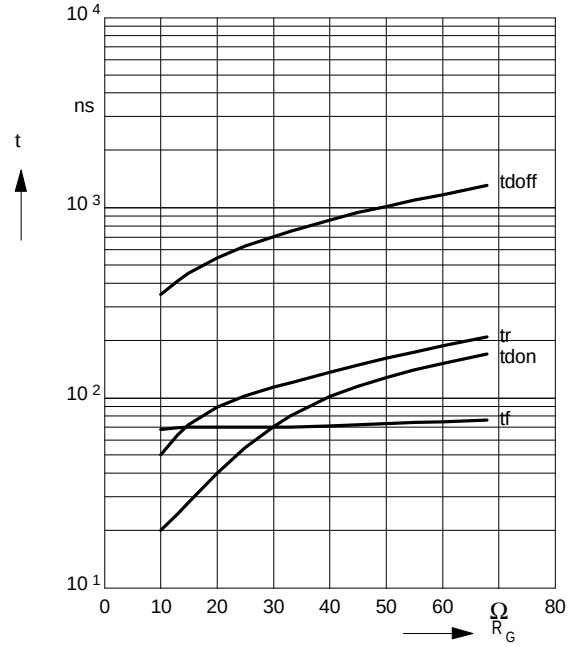
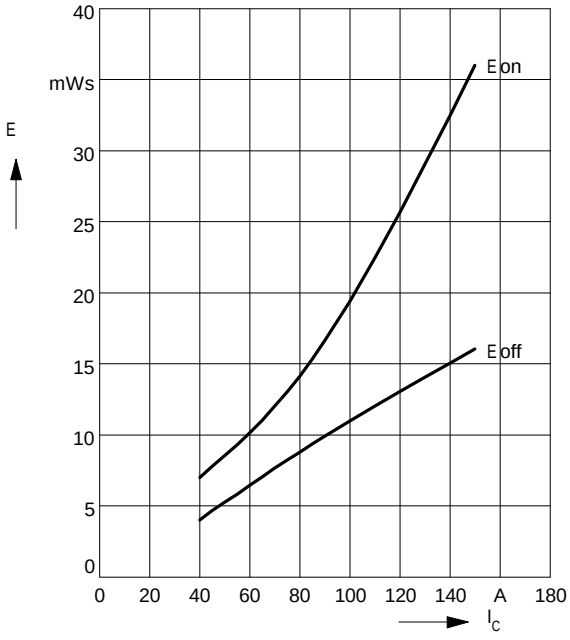
Typ. switching time
I = f (I_C) , inductive load , T_j = 125°C
par.: V_{CE} = 600 V, V_{GE} = ± 15V, R_G = 15 Ω



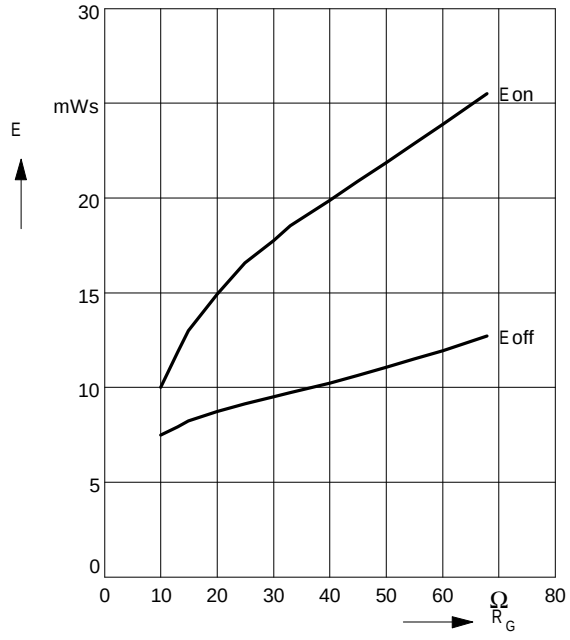
Typ. switching time
t = f (R_G) , inductive load , T_j = 125°C
par.: V_{CE} = 600V, I_C = 75 A



Typ. switching losses
E = f (I_C) , inductive load , T_j = 125°C
par.: V_{CE} = 600 V, V_{GE} = ± 15 V, R_G = 15 Ω



Typ. switching losses
E = f (R_G) , inductive load , T_j = 125°C
par.: V_{CE} = 600 V, V_{GE} = ± 15 V, I_C = 75 A



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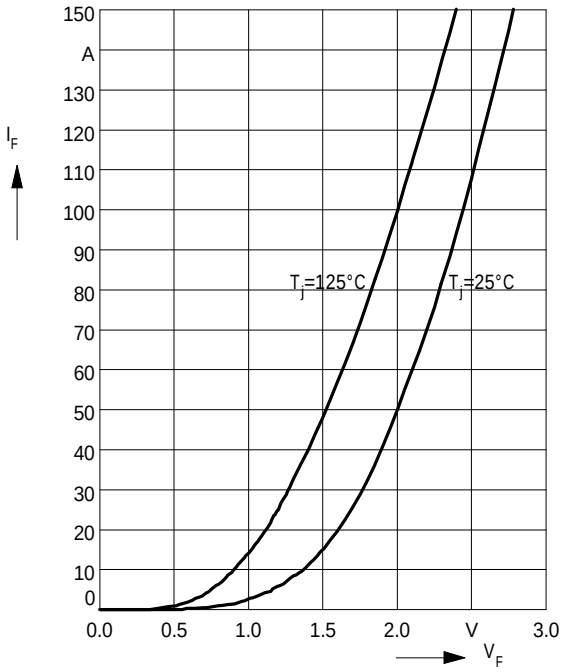
Forward characteristics of fast recovery reverse diode $I_F = f(V_F)$
parameter: T_j



Transient thermal impedance Diode
$Z_{th\,JC} = f(t_p)$
parameter: $D = t_p / T$